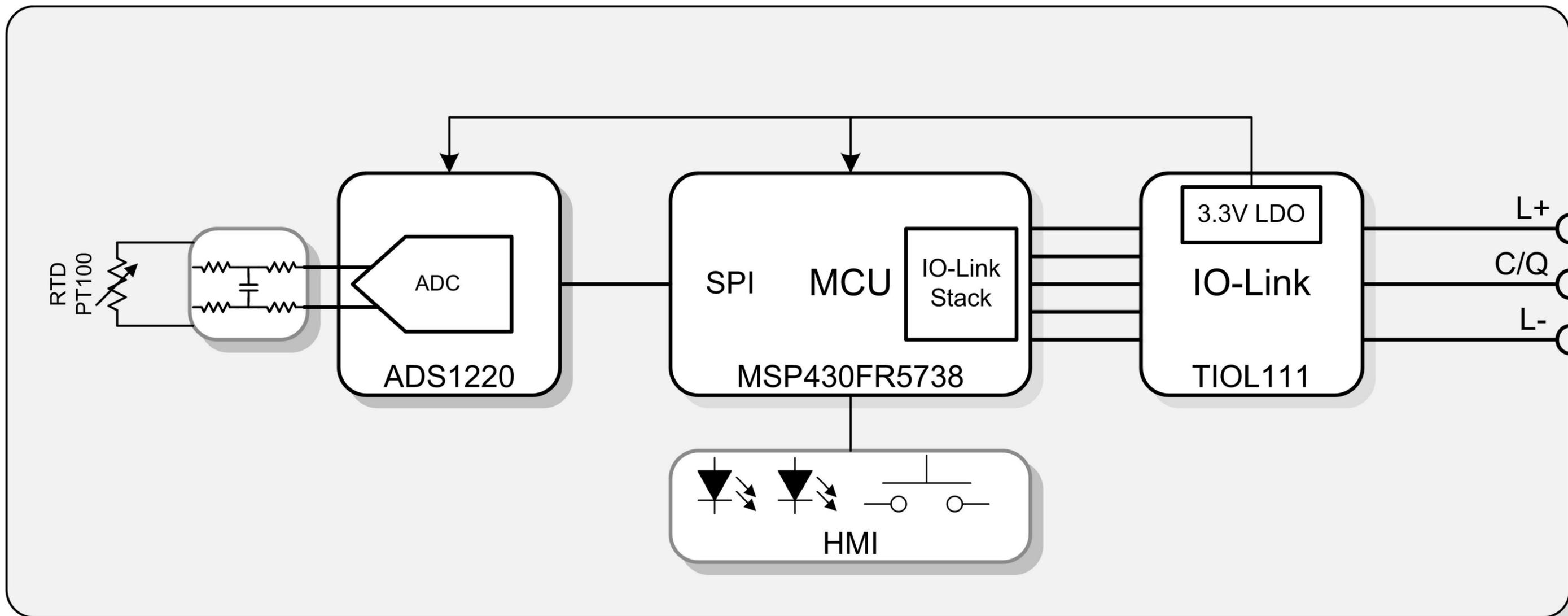
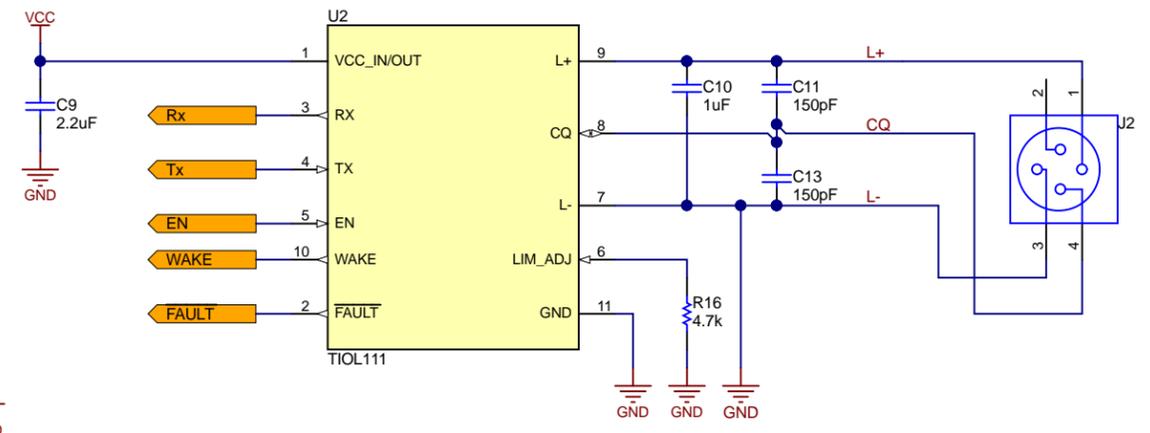
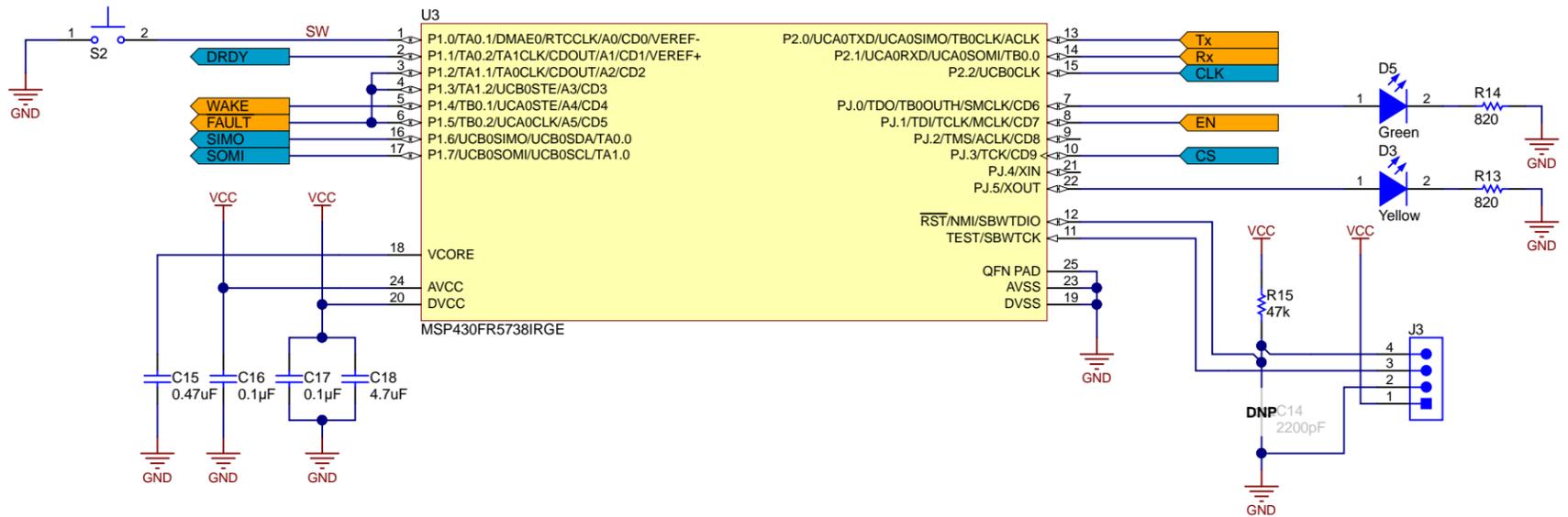
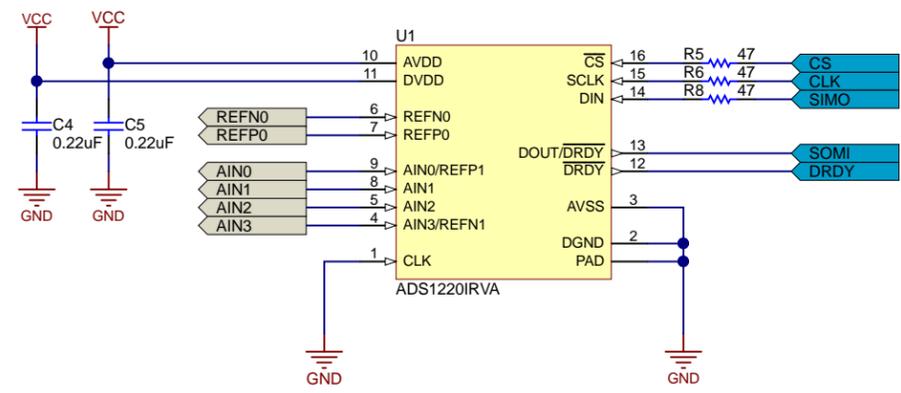
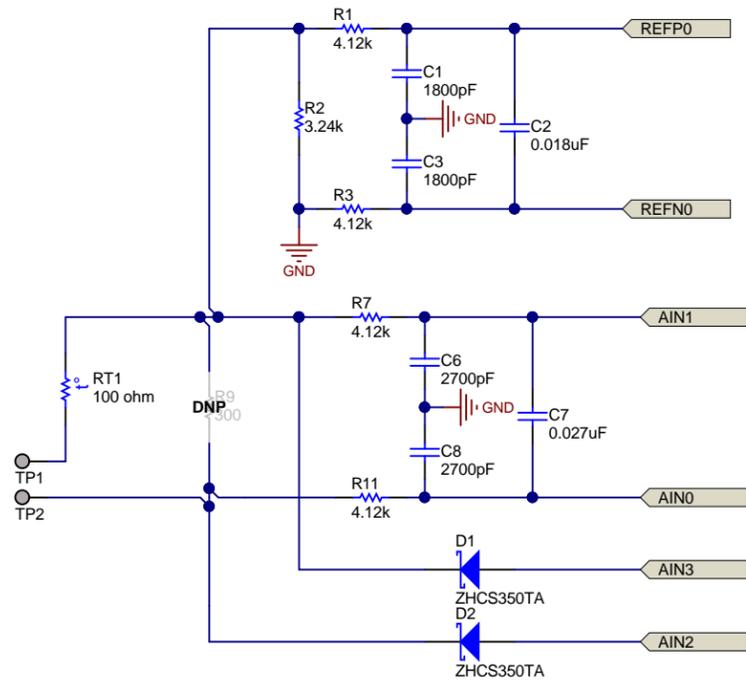


Revision History				
Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A



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TID #: TIDA-01335	Project Title: IO-Link Sensor Transmitter with RTD Front-end	
Number: TIDA-01335	Rev: E1	Sheet Title: Block Diagram
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 3
Drawn By: AW	File: TIDA-01335E1_CoverSheet.SchDoc	Size: B
Engineer: AW	Contact: http://www.ti.com/support	



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TID #: TIDA-01335	Project Title: IO-Link Sensor Transmitter with RTD Front-end	
Number: TIDA-01335	Rev: E1	Sheet Title: Schematic
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By: AW	File: TIDA-01335E1_Schematic.SchDoc	Size: B
Engineer: AW	Contact: http://www.ti.com/support	



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PCB
LOGO
Pb-Free Symbol

ZZ2
Assembly Note
This Assembly Note will show in the PcbDoc and associated outputs

ZZ3
Assembly Note
This Assembly Note will show in the PcbDoc and associated outputs

ZZ4
Assembly Note
This Assembly Note will show in the PcbDoc and associated outputs

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Number: TIDA-01335	Rev: E1	Sheet Title: Hardware	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 3 of 3	
Drawn By: AW	File: TIDA-01335E1_EVM_Hardware.SchDoc	Size: B	
Engineer: AW	Contact: http://www.ti.com/support		

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